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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	40MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	36
Program Memory Size	4KB (2K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 13x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-VQFN Exposed Pad
Supplier Device Package	44-QFN (8x8)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf4221-i-ml

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

1.0 DEVICE OVERVIEW

This document contains device specific information for the following devices:

- PIC18F2221 PIC18LF2221
- PIC18F2321 PIC18LF2321
- PIC18F4221 PIC18LF4221
- PIC18F4321 PIC18LF4321

This family offers the advantages of all PIC18 microcontrollers – namely, high computational performance at an economical price – with the addition of highendurance, Enhanced Flash program memory. On top of these features, the PIC18F2221/2321/4221/4321 family introduces design enhancements that make these microcontrollers a logical choice for many high-performance, power sensitive applications.

1.1 New Core Features

1.1.1 nanoWatt TECHNOLOGY

All of the devices in the PIC18F2221/2321/4221/4321 family incorporate a range of features that can significantly reduce power consumption during operation. Key items include:

- Alternate Run Modes: By clocking the controller from the Timer1 source or the internal oscillator block, power consumption during code execution can be reduced by as much as 90%.
- Multiple Idle Modes: The controller can also run with its CPU core disabled but the peripherals still active. In these states, power consumption can be reduced even further, to as little as 4% of normal operation requirements.
- On-the-Fly Mode Switching: The power-managed modes are invoked by user code during operation, allowing the user to incorporate power-saving ideas into their application's software design.
- Low Consumption in Key Modules: The power requirements for both Timer1 and the Watchdog Timer are minimized. See Section 27.0 "Electrical Characteristics" for values.

1.1.2 MULTIPLE OSCILLATOR OPTIONS AND FEATURES

All of the devices in the PIC18F2221/2321/4221/4321 family offer ten different oscillator options, allowing users a wide range of choices in developing application hardware. These include:

- Four Crystal modes, using crystals or ceramic resonators.
- Two External Clock modes, offering the option of using two pins (oscillator input and a divide-by-4 clock output) or one pin (oscillator input, with the second pin reassigned as general I/O).
- Two External RC Oscillator modes with the same pin options as the External Clock modes.
- Two Internal Oscillator modes which provide an 8 MHz clock and an INTRC source (approximately 31 kHz), as well as a range of 6 user-selectable clock frequencies, between 125 kHz to 4 MHz, for a total of 8 clock frequencies. One or both of the oscillator pins can be used for general purpose I/O.
- A Phase Lock Loop (PLL) frequency multiplier, available to both the high-speed crystal and internal oscillator modes, which allows clock speeds of up to 40 MHz. Used with the internal oscillator, the PLL gives users a complete selection of clock speeds, from 31 kHz to 32 MHz – all without using an external crystal or clock circuit.

Besides its availability as a clock source, the internal oscillator block provides a stable reference source that gives the family additional features for robust operation:

- Fail-Safe Clock Monitor: This option constantly monitors the main clock source against a reference signal provided by the internal oscillator. If a clock failure occurs, the controller is switched to the internal oscillator block, allowing for continued low-speed operation or a safe application shutdown.
- **Two-Speed Start-up:** This option allows the internal oscillator to serve as the clock source from Power-on Reset, or wake-up from Sleep mode, until the primary clock source is available.



FIGURE 1-1: PIC18F2221/2321 (28-PIN) BLOCK DIAGRAM

Note 1: CCP2 is multiplexed with RC1 when Configuration bit, CCP2MX, is set, or RB3 when CCP2MX is not set.

2: RE3 is only available when $\overline{\text{MCLR}}$ functionality is disabled.

3: OSC1/CLKI and OSC2/CLKO are only available in select oscillator modes and when these pins are not being used as digital I/O. Refer to Section 3.0 "Oscillator Configurations" for additional information.

Dia Mara	Pi	n Numt	ber	Pin	Buffer	Description			
Pin Name	PDIP	QFN	TQFP	Туре	Туре	Description			
						PORTB is a bidirectional I/O port. PORTB can be software programmed for internal weak pull-ups on all inputs.			
RB0/INT0/FLT0/AN12 RB0 INT0 FLT0 AN12	33	9	8	I/O I I	TTL ST ST Analog	Digital I/O. External Interrupt 0. PWM Fault input for Enhanced CCP1. Analog input 12.			
RB1/INT1/AN10 RB1 INT1 AN10	34	10	9	I/O I I	TTL ST Analog	Digital I/O. External Interrupt 1. Analog Input 10.			
RB2/INT2/AN8 RB2 INT2 AN8	35	11	10	I/O I I	TTL ST Analog	Digital I/O. External Interrupt 2. Analog Input 8.			
RB3/AN9/CCP2 RB3 AN9 CCP2 ⁽²⁾	36	12	11	I/O I I/O	TTL Analog ST	Digital I/O. Analog Input 9. Capture 2 input/Compare 2 output/PWM2 output.			
RB4/KBI0/AN11 RB4 KBI0 AN11	37	14	14	I/O I I	TTL TTL Analog	Digital I/O. Interrupt-on-change pin. Analog input 11.			
RB5/KBI1/PGM RB5 KBI1 PGM	38	15	15	I/O I I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. Low-Voltage ICSP™ Programming enable pin.			
RB6/KBI2/PGC RB6 KBI2 PGC	39	16	16	I/O I I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-circuit debugger and ICSP programming clock pin.			
RB7/KBI3/PGD RB7 KBI3 PGD	40	17	17	I/O I I/O	TTL TTL ST	Digital I/O. Interrupt-on-change pin. In-circuit debugger and ICSP programming data pin.			
Legend: TTL = TTL c ST = Schm I^2C = ST wi	Legend:TTL = TTL compatible inputCMOS = CMOS compatible input or outputST = Schmitt Trigger input with CMOS levelsI= InputP = Power I^2C = ST with I^2C^{TM} or SMB levelsO= Output								

TABLE 1-3: PIC18F4221/4321 PINOUT I/O DESCRIPTIONS (CONTINUED)

Note 1: Default assignment for CCP2 when Configuration bit, CCP2MX, is set.

2: Alternate assignment for CCP2 when Configuration bit, CCP2MX, is cleared.

Din Nome	Pi	n Numt	ber	Pin	Buffer	Description		
	PDIP	QFN	TQFP	Туре	Туре	Description		
						PORTD is a bidirectional I/O port or a Parallel Slave Port (PSP) for interfacing to a microprocessor port. These pins have TTL input buffers when the PSP module is enabled.		
RD0/PSP0 RD0 PSP0	19	38	38	I/O I/O	ST TTL	Digital I/O. Parallel Slave Port data.		
RD1/PSP1 RD1 PSP1	20	39	39	I/O I/O	ST TTL	Digital I/O. Parallel Slave Port data.		
RD2/PSP2 RD2 PSP2	21	40	40	I/O I/O	ST TTL	Digital I/O. Parallel Slave Port data.		
RD3/PSP3 RD3 PSP3	22	41	41	I/O I/O	ST TTL	Digital I/O. Parallel Slave Port data.		
RD4/PSP4 RD4 PSP4	27	2	2	I/O I/O	ST TTL	Digital I/O. Parallel Slave Port data.		
RD5/PSP5/P1B RD5 PSP5 P1B	28	3	3	I/O I/O O	ST TTL	Digital I/O. Parallel Slave Port data. Enhanced CCP1 output.		
RD6/PSP6/P1C RD6 PSP6 P1C	29	4	4	I/O I/O O	ST TTL	Digital I/O. Parallel Slave Port data. Enhanced CCP1 output.		
RD7/PSP7/P1D RD7 PSP7 P1D	30	5	5	I/O I/O O	ST TTL	Digital I/O. Parallel Slave Port data. Enhanced CCP1 output.		
Legend:TTL = TTL compatible inputCMOS = CMOS compatible input or outputST = Schmitt Trigger input with CMOS levelsI= InputP = Power $I^2C = ST$ with I^2C^{TM} or SMB levelsO= Output								

TABLE 1-3: PIC18F4221/4321 PINOUT I/O DESCRIPTIONS (CONTINUED)

Note 1: Default assignment for CCP2 when Configuration bit, CCP2MX, is set.

2: Alternate assignment for CCP2 when Configuration bit, CCP2MX, is cleared.

2.0 GUIDELINES FOR GETTING STARTED WITH PIC18F MICROCONTROLLERS

2.1 Basic Connection Requirements

Getting started with the PIC18F2221/2321/4221/4321 family family of 8-bit microcontrollers requires attention to a minimal set of device pin connections before proceeding with development.

The following pins must always be connected:

- All VDD and Vss pins (see Section 2.2 "Power Supply Pins")
- All AVDD and AVss pins, regardless of whether or not the analog device features are used (see Section 2.2 "Power Supply Pins")
- MCLR pin
 (see Section 2.3 "Master Clear (MCLR) Pin")

These pins must also be connected if they are being used in the end application:

- PGC/PGD pins used for In-Circuit Serial Programming[™] (ICSP[™]) and debugging purposes (see **Section 2.4 "ICSP Pins"**)
- OSCI and OSCO pins when an external oscillator source is used

(see Section 2.5 "External Oscillator Pins")

Additionally, the following pins may be required:

• VREF+/VREF- pins used when external voltage reference for analog modules is implemented

Note:	The AVDD and AVSS pins must always be
	connected, regardless of whether any of
	the analog modules are being used.

The minimum mandatory connections are shown in Figure 2-1.

FIGURE 2-1: RECOMMENDED MINIMUM CONNECTIONS



TABLE 3-2:CAPACITOR SELECTION FOR
QUARTZ CRYSTALS

Osc Type	Crystal	Typical Capa Tes	citor Values ted:	
	Fieq	C1	C2	
LP	32 kHz	22 pF	22 pF	
ХТ	1 MHz 4 MHz	22 pF 22 pF	22 pF 22 pF	
HS	4 MHz 10 MHz 20 MHz 25 MHz	22 pF 22 pF 22 pF 22 pF 22 pF	22 pF 22 pF 22 pF 22 pF 22 pF	

Capacitor values are for design guidance only.

Different capacitor values may be required to produce acceptable oscillator operation. The user should test the performance of the oscillator over the expected VDD and temperature range for the application. Refer to the following application notes for oscillator specific information:

- AN588, "PIC[®] Microcontroller Oscillator Design Guide"
- AN826, "Crystal Oscillator Basics and Crystal Selection for rfPIC[®] and PIC[®] Devices"
- AN849, "Basic PIC[®] Oscillator Design"
- AN943, "Practical PIC[®] Oscillator Analysis and Design"
- · AN949, "Making Your Oscillator Work"

See the notes following this table for additional information.

- **Note 1:** Higher capacitance increases the stability of the oscillator but also increases the start-up time.
 - When operating below 3V VDD, or when using certain ceramic resonators at any voltage, it may be necessary to use the HS mode or switch to a crystal oscillator.
 - Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.
 - 4: Rs may be required to avoid overdriving crystals with low drive level specification.
 - **5:** Always verify oscillator performance over the VDD and temperature range that is expected for the application.

An external clock source may also be connected to the OSC1 pin in the HS mode, as shown in Figure 3-2. When operated in this mode, parameters D033 and D043 apply.



3.3 External Clock Input

The EC and ECIO Oscillator modes require an external clock source to be connected to the OSC1 pin. There is no oscillator start-up time required after a Power-on Reset or after an exit from Sleep mode.

In the EC Oscillator mode, the oscillator frequency divided by 4 is available on the OSC2 pin. This signal may be used for test purposes or to synchronize other logic. Figure 3-3 shows the pin connections for the EC Oscillator mode.

FIGURE 3-3:

EXTERNAL CLOCK INPUT OPERATION (EC CONFIGURATION)



The ECIO Oscillator mode functions like the EC mode, except that the OSC2 pin becomes an additional general purpose I/O pin. The I/O pin becomes bit 6 of PORTA (RA6). Figure 3-4 shows the pin connections for the ECIO Oscillator mode. When operated in this mode, parameters D033A and D043A apply.



EXTERNAL CLOCK INPUT OPERATION (ECIO CONFIGURATION)



4.1.3 CLOCK TRANSITIONS AND STATUS INDICATORS

The length of the transition between clock sources is the sum of two cycles of the old clock source and three to four cycles of the new clock source. This formula assumes that the new clock source is stable.

Three bits indicate the current clock source and its status. They are:

- OSTS (OSCCON<3>)
- IOFS (OSCCON<2>)
- T1RUN (T1CON<6>)

In general, only one of these bits will be set while in a given power-managed mode. When the OSTS bit is set, the primary clock is providing the device clock. When the IOFS bit is set, the INTOSC output is providing a stable 8 MHz clock source to a divider that actually drives the device clock. When the T1RUN bit is set, the Timer1 oscillator is providing the clock. If none of these bits are set, then either the INTRC clock source is clocking the device, or the INTOSC source is not yet stable.

If the internal oscillator block is configured as the primary clock source by the FOSC<3:0> Configuration bits, then both the OSTS and IOFS bits may be set when in PRI_RUN or PRI_IDLE modes. This indicates that the primary clock (INTOSC) is generating a stable 8 MHz output. Switching the clock source to the Timer1 oscillator would clear the OSTS bit.

- Note 1: Caution should be used when modifying a single IRCF bit. If VDD is less than 3V, it is possible to select a higher clock speed than is supported by the low VDD. Improper device operation may result if the VDD/Fosc specifications are violated.
 - 2: Executing a SLEEP instruction does not necessarily place the device into Sleep mode. It acts as the trigger to place the controller into either the Sleep mode or one of the Idle modes, depending on the setting of the IDLEN bit.

4.1.4 MULTIPLE SLEEP COMMANDS

The power-managed mode that is invoked with the SLEEP instruction is determined by the setting of the IDLEN bit at the time the instruction is executed. If another SLEEP instruction is executed, the device will enter the power-managed mode specified by IDLEN at that time. If IDLEN has changed, the device will enter the new power-managed mode specified by the new setting.

4.2 Run Modes

In the Run modes, clocks to both the core and peripherals are active. The difference between these modes is the clock source.

4.2.1 PRI_RUN MODE

The PRI_RUN mode is the normal, full power execution mode of the microcontroller. This is also the default mode upon a device Reset unless Two-Speed Start-up is enabled (see Section 24.3 "Two-Speed Start-up" or Section 24.4 "Fail-Safe Clock Monitor" for details). In this mode, the OSTS bit is set. The IOFS bit may be set if the internal oscillator block is the primary clock source (see Section 3.7.1 "Oscillator Control Register").

4.2.2 SEC_RUN MODE

The SEC_RUN mode is the compatible mode to the "clock switching" feature offered in other PIC18 devices. In this mode, the CPU and peripherals are clocked from the Timer1 oscillator. This gives users the option of lower power consumption while still using a high-accuracy clock source.

SEC_RUN mode is entered by setting the SCS<1:0> bits to '01'. The device clock source is switched to the Timer1 oscillator (see Figure 4-1), the primary oscillator is shut down, the T1RUN bit (T1CON<6>) is set and the OSTS bit is cleared.

Note: The Timer1 oscillator should already be running prior to entering SEC_RUN mode. If the T1OSCEN bit is not set when the SCS<1:0> bits are set to '01', entry to SEC_RUN mode will not occur. If the Timer1 oscillator is enabled, but not yet running, device clocks will be delayed until the oscillator has started. In such situations, initial oscillator operation is far from stable and unpredictable operation may result.

On transitions from SEC_RUN mode to PRI_RUN, the peripherals and CPU continue to be clocked from the Timer1 oscillator while the primary clock is started. When the primary clock becomes ready, a clock switch back to the primary clock occurs (see Figure 4-2). When the clock switch is complete, the T1RUN bit is cleared, the OSTS bit is set and the primary clock is providing the clock. The IDLEN and SCS bits are not affected by the wake-up; the Timer1 oscillator continues to run.

FIGURE 6-8: COMPARING ADDRESSING OPTIONS FOR BIT-ORIENTED AND BYTE-ORIENTED INSTRUCTIONS (EXTENDED INSTRUCTION SET ENABLED)



When 'a' = 0 and 'f' \geq 60h:

The instruction executes in Direct Forced mode. 'f' is interpreted as a location in the Access RAM between 060h and 0FFh. This is the same as locations 060h to 07Fh (Bank 0) and F80h to FFFh (Bank 15) of data memory.

Locations below 60h are not available in this addressing mode.

When 'a' = 0 and 'f' \leq 5Fh:

The instruction executes in Indexed Literal Offset mode. 'f' is interpreted as an offset to the address value in FSR2. The two are added together to obtain the address of the target register for the instruction. The address can be anywhere in the data memory space.

Note that in this mode, the correct syntax is now: ADDWF [k], d where 'k' is the same as 'f'.

When 'a' = 1 (all values of 'f'):

The instruction executes in Direct mode (also known as Direct Long mode). 'f' is interpreted as a location in one of the 16 banks of the data memory space. The bank is designated by the Bank Select Register (BSR). The address can be in any implemented bank in the data memory space.



REGISTER 7-1:	REGISTER 7-1: EECON1: DATA EEPROM CONTROL REGISTER 1									
	R/W-x	R/W-x	U-0	R/W-0	R/W-x	R/W-0	R/S-0	R/S-0		
	EEPGD	CFGS	—	FREE	WRERR	WREN	WR	RD		
	bit 7							bit 0		
bit 7	EEPGD: F	lash Prograr	n or Data El	EPROM Me	mory Select	bit				
	 1 = Access Flash program memory 0 = Access data EEPROM memory 									
bit 6	CFGS: Fla	sh Program/	Data EEPR	OM or Conf	iguration Sel	lect bit				
	1 = Acces 0 = Acces	 1 = Access Configuration registers 0 = Access Flash program or data EEPROM memory 								
bit 5	Unimplem	ented: Read	d as '0'							
bit 4	FREE: Flas	sh Row Eras	e Enable bi	t						
	 1 = Erase the program memory row addressed by TBLPTR on the next WR command (cleared by completion of erase operation) 0 = Perform write-only 									
bit 3	WRERR: Flash Program/Data EEPROM Error Flag bit									
	 1 = A write operation is prematurely terminated (any Reset during self-timed programming in normal operation, or an improper write attempt) 0 = The write operation completed 									
	Note:	When a Wi This allows	RERR occur tracing of th	rs, the EEPC	D and CFG dition.	S bits are n	ot cleared.			
bit 2	WREN: Fla	ash Program	/Data EEPF	ROM Write E	nable bit					
	1 = Allows 0 = Inhibits	write cycles s write cycle	s to Flash pr s to Flash p	ogram/data rogram/data	EEPROM EEPROM					
bit 1	WR: Write	Control bit								
	 1 = Initiates a data EEPROM erase/write cycle or a program memory erase/write cycle. (The operation is self-timed and the bit is cleared by hardware once write is complete. The WR bit can only be set (not cleared) in software.) 0 = Write cycle to the EEPROM is complete 									
bit 0	RD: Read Control bit									
	 1 = Initiates an EEPROM read (Read takes one cycle. RD is cleared in hardware. The RD bit can only be set (not cleared) in software. RD bit cannot be set when EEPGD = 1 or CFGS = 1.) 0 = Does not initiate an EEPROM read 									
	Legend:									
	R = Reada	ble bit	W = W	/ritable bit						
	S = Bit can	be set by s	oftware, but	not cleared	U = Unim	plemented	bit, read as	'0'		

'1' = Bit is set

'0' = Bit is cleared

-n = Value at POR

x = Bit is unknown

REGISTER 8-1: EECON1: DATA EEPROM CONTROL REGISTER 1											
	R/W-x	R/W-x	U-0	R/W-0	R/W-x	R/W-0	R/S-0	R/S-0			
	EEPGD	CFGS	—	FREE	WRERR	WREN	WR	RD			
	bit 7							bit 0			
bit 7	EEPGD: FI	lash Progran	n or Data El	EPROM Me	mory Select	bit					
	1 = Access 0 = Access	s Flash progr s data EEPR	am memory OM memory	/ y							
bit 6	CFGS: Fla	sh Program/	Data EEPR	OM or Conf	iguration Sel	lect bit					
	1 = Access 0 = Access	s Configurations Flash progr	on registers am or data	EEPROM m	nemory						
bit 5	Unimplem	ented: Read	as '0'								
bit 4	FREE: Flas	sh Row Eras	e Enable bi	t							
	1 = Erase by con 0 = Perfor	the program npletion of e m write only	memory rov rase operati	w addressed ion)	by TBLPTR	on the next	WR comma	nd (cleared			
bit 3	WRERR: Flash Program/Data EEPROM Error Flag bit										
	1 = A write norma 0 = The wr	e operation is I operation, o rite operation	s premature or an improj n completec	ely terminate per write atte	d (any Rese empt)	et during sel	f-timed prog	ramming in			
	Note: When a WRERR occurs, the EEPGD and CFGS bits are not cleared. This allows tracing of the error condition.										
bit 2	WREN: Flash Program/Data EEPROM Write Enable bit 1 = Allows write cycles to Flash program/data EEPROM										
bit 1	WR: Write	Control bit		rogram aata							
	n memory e ardware ond	rase cycle or ce write is cc	write cycle mplete.								
bit 0	RD: Read Control bit										
	 1 = Initiates an EEPROM read (Read takes one cycle. RD is cleared in hardware. The RD bit can only be set (not cleared) in software. RD bit cannot be set when EEPGD = 1 or CFGS = 1.) a = Does not initiate an EEPROM read 										
	Legend:										

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented I	bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

0-3.	INTCONS		PT CONTI		SIERS							
	R/W-1	R/W-1	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0				
	INT2IP	INT1IP		INT2IE	INT1IE	_	INT2IF	INT1IF				
	bit 7							bit 0				
oit 7	INT2IP: IN	T2 External I	nterrupt Pri	ority bit								
	1 = High p 0 = Low pr	1 = High priority0 = Low priority										
oit 6	INT1IP: IN	T1 External I	nterrupt Pri	ority bit								
	1 = High p 0 = Low pi	1 = High priority 0 = Low priority										
bit 5	Unimplem	ented: Read	as '0'									
bit 4	INT2IE: IN	T2 External I	nterrupt En	able bit								
	1 = Enable 0 = Disable	es the INT2 e	external inte	errupt errupt								
bit 3		T1 External I	nterrupt En	able bit								
	1 = Enable 0 = Disable	es the INT1 e es the INT1 e	external inte	errupt errupt								
bit 2	Unimplem	ented: Read	as '0'									
bit 1	INT2IF: IN	T2 External I	nterrupt Fla	g bit								
	1 = The IN 0 = The IN	 1 = The INT2 external interrupt occurred (must be cleared in software) 0 = The INT2 external interrupt did not occur 										
bit 0	INT1IF: IN	T1 External I	nterrupt Fla	g bit								
	1 = The IN 0 = The IN	IT1 external i IT1 external i	nterrupt oc nterrupt dic	curred (mus I not occur	t be cleared	in software)						
	Legend:											

REGISTER 10-3: INTCON3: INTERRUPT CONTROL REGISTER 3

Legena:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the global interrupt enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

11.5 PORTE, TRISE and LATE Registers

Depending on the particular PIC18F2221/2321/4221/ 4321 family device selected, PORTE is implemented in two different ways.

For 40/44-pin devices, PORTE is a 4-bit wide port. Three pins (RE0/RD/AN5, RE1/WR/AN6 and RE2/CS/ AN7) are individually configurable as inputs or outputs. These pins have Schmitt Trigger input buffers. When selected as analog inputs, these pins will read as '0'.

The corresponding Data Direction register is TRISE. Setting a TRISE bit (= 1) will make the corresponding PORTE pin an input (i.e., put the corresponding output driver in a High-Impedance mode). Clearing a TRISE bit (= 0) will make the corresponding PORTE pin an output (i.e., put the contents of the output latch on the selected pin).

TRISE controls the direction of the RE pins, even when they are being used as analog inputs. The user must make sure to keep the pins configured as inputs when using them as analog inputs.

Note:	On	а	Power-on	Reset,	RE<2:0>	are
	cont	figu	red as anal	og input	S.	

The upper four bits of the TRISE register also control the operation of the Parallel Slave Port. Their operation is explained in Register 11-1.

The Data Latch register (LATE) is also memory mapped. Read-modify-write operations on the LATE register, read and write the latched output value for PORTE.

The fourth pin of PORTE ($\overline{\text{MCLR}}/\text{VPP}/\text{RE3}$) is an input only pin. Its operation is controlled by the MCLRE Configuration bit. When selected as a port pin (MCLRE = 0), it functions as a digital input only pin; as such, it does not have TRIS or LAT bits associated with its operation. Otherwise, it functions as the device's Master Clear input. In either configuration, RE3 also functions as the programming voltage input during programming.

Note:	On a Pow	er-on R	leset,	RE	3 is enab	led as			
	a digital	input	only	if	Master	Clear			
	functionality is disabled.								

EXAMPLE 11-5: INITIALIZING PORTE

CLRF	PORTE	; Initialize PORTE by ; clearing output
		; data latches
CLRF	LATE	; Alternate method
		; to clear output
		; data latches
MOVLW	OFh	; Configure A/D
MOVWF	ADCON1	; for digital inputs
MOVLW	03h	; Value used to
		; initialize data
		; direction
MOVWF	TRISE	; Set RE<0> as inputs
		; RE<1> as outputs
		; RE<2> as inputs
1		

11.5.1 PORTE IN 28-PIN DEVICES

For 28-pin devices, PORTE is only available when Master Clear functionality is disabled (MCLRE = 0). In these cases, PORTE is a single bit, input only port comprised of RE3 only. The pin operates as previously described.

11.6 Parallel Slave Port

Note:	The Parallel Slave Port is only available on
	40/44-pin devices.

In addition to its function as a general I/O port, PORTD can also operate as an 8-bit wide Parallel Slave Port (PSP) or microprocessor port. PSP operation is controlled by the 4 upper bits of the TRISE register (Register 11-1). Setting control bit, PSPMODE (TRISE<4>), enables PSP operation as long as the Enhanced CCP module is not operating in Dual Output or Quad Output PWM mode. In Slave mode, the port is asynchronously readable and writable by the external world.

The PSP can directly interface to an 8-bit microprocessor data bus. The external microprocessor can read or write the PORTD latch as an 8-bit latch. Setting the control bit, PSPMODE, enables the PORTE I/O pins to become control inputs for the microprocessor port. When set, port pin RE0 is the RD input, RE1 is the WR input and RE2 is the CS (Chip Select) input. For this functionality, the corresponding data direction bits of the TRISE register (TRISE<2:0>) must be configured as inputs (set). The A/D port configuration bits, PFCG<3:0> (ADCON1<3:0>), must also be set to a value in the range of '1010' through '1111'.

A write to the PSP occurs when both the $\overline{\text{CS}}$ and $\overline{\text{WR}}$ lines are first detected low and ends when either are detected high. The PSPIF and IBF flag bits are both set when the write ends.

A read from the PSP occurs when both the \overline{CS} and \overline{RD} lines are first detected low. The data in PORTD is read out and the OBF bit is clear. If the user writes new data to PORTD to set OBF, the data is immediately read out; however, the OBF bit is not set.

When either the \overline{CS} or \overline{RD} lines are detected high, the PORTD pins return to the input state and the PSPIF bit is set. User applications should wait for PSPIF to be set before servicing the PSP. When this happens, the IBF and OBF bits can be polled and the appropriate action taken. The timing for the control signals in Write and Read modes is shown in Figure 11-3 and Figure 11-4, respectively.





18.4.3.2 Address Masking

Masking an address bit causes that bit to become a "don't care". When one address bit is masked, two addresses will be Acknowledged and cause an interrupt. It is possible to mask more than one address bit at a time, which makes it possible to Acknowledge up to 31 addresses in 7-Bit Addressing mode and up to 63 addresses in 10-Bit Addressing mode (see Example 18-2).

The l^2C slave behaves the same way whether address masking is used or not. However, when address masking is used, the l^2C slave can Acknowledge multiple addresses and cause interrupts. When this occurs, it is necessary to determine which address caused the interrupt by checking the SSPBUF register.

• 7-Bit Addressing mode

Address mask bits, ADMSK<5:1>, mask the corresponding address bits in the SSPADD register. For any ADMSK bits that are active (ADMSK<n> = 1), the corresponding address bit is ignored (ADD<n> = x). For the module to issue an address Acknowledge, it is sufficient to match only on addresses that do not have an active address mask.

• 10-Bit Addressing mode

Address mask bits, ADMSK<5:2>, mask the corresponding address bits in the SSPADD register. In addition, ADMSK<1> simultaneously masks the two LSBs of the address, ADD<1:0>. For any ADMSK bits that are active (ADMSK<n> = 1), the corresponding address bit is ignored (ADD<n> = x). Also note that although in 10-Bit Addressing mode, the upper address bits reuse part of the SSPADD register bits, the address mask bits do not interact with those bits. They only affect the lower address bits.

Note 1: ADMSK<1> masks the two Least Significant bits of the address.

2: The two Most Significant bits of the address are not affected by address masking.

EXAMPLE 18-2: ADDRESS MASKING

7-Bit Addressing mode:

SSPADD<7:1> = 1010 0000

ADMSK<5:1> = 00 111

Addresses Acknowledged = 0xA0, 0xA2, 0xA4, 0xA6, 0xA8, 0xAA, 0xAC, 0xAE

10-Bit Addressing mode:

SSPADD<7:0> = 1010 0000 (The two MSbs are ignored in this example since they are not affected)

ADMSK<5:1> = 00 111

Addresses Acknowledged = 0xA0, 0xA1, 0xA2, 0xA3, 0xA4, 0xA5, 0xA6, 0xA7, 0xA8, 0xA9, 0xAA, 0xAB, 0xAC, 0xAD, 0xAE, 0xAF

The upper two bits are not affected by the address masking.



REGISTER 19-2:	RCSTA: RECEIVE STATUS AND CONTROL REGISTER								
	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0	R-x	
	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	
	bit 7							bit 0	
bit 7	SPEN: Ser	rial Port Ena	ble bit						
	 1 = Serial port enabled (configures RX/DT and TX/CK pins as serial port pins) 0 = Serial port disabled (held in Reset) 								
bit 6	6 RX9: 9-bit Receive Enable bit								
	1 = Selects 0 = Selects	s 9-bit recep s 8-bit recep	tion tion						
bit 5	SREN: Sin	gle Receive	Enable bit						
	<u>Asynchron</u> Don't care.	ous mode:							
	Synchrono 1 = Enable 0 = Disable	<u>Synchronous mode – Master:</u> 1 = Enables single receive 0 = Disables single receive							
	This bit is cleared after reception is complete. Synchronous mode – Slave:								
bit 4	Don t care.								
DIL 4									
	1 = Enables receiver								
	Synchronous mode:								
	 1 = Enables continuous receive until enable bit CREN is cleared (CREN overrides SREN) 0 = Disables continuous receive 								
bit 3	ADDEN: Address Detect Enable bit								
	Asynchronous mode 9-bit (RX9 = 1): 1 = Enables address detection, enables interrupt and loads the receive buffer when RSR<8> is set 0 = Disables address detection, all bytes are received and pinth bit can be used as parity bit								
	Asynchronous mode 9-bit (RX9 = 0): Don't care.								
bit 2	FERR: Framing Error bit								
	 1 = Framing error (can be updated by reading RCREG register and receiving next valid byte) 0 = No framing error 								
bit 1	OERR: Overrun Error bit								
	 1 = Overrun error (can be cleared by clearing bit CREN) 0 = No overrun error 								
bit 0	RX9D: 9th bit of Received Data								
	This can be address/data bit or a parity bit and must be calculated by user firmware.								
	l egend:]	
	R = Reada	ble bit	M = M	/ritable bit	[] = []nim	plemented	bit read as	ʻ0'	
	-n = Value	at POR	'1' = B	it is set	'0' = Bit i	s cleared	x = Bit is u	Inknown	

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	55
PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	58
PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	58
IPR1	PSPIP ⁽¹⁾	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	58
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	57
TXREG	EUSART Transmit Register								57
TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	57
BAUDCON	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	—	WUE	ABDEN	57
SPBRGH	EUSART Baud Rate Generator Register High Byte								57
SPBRG	EUSART B	Baud Rate G	enerator Re	gister Low E	Byte				57

TABLE 19-5: REGISTERS ASSOCIATED WITH ASYNCHRONOUS TRANSMISSION

Legend: — = unimplemented locations read as '0'. Shaded cells are not used for asynchronous transmission.

Note 1: These bits are unimplemented on 28-pin devices and read as '0'.

File	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
300008h	CONFIG5L		_	_	—	—	_	CP1	CP0
300009h	CONFIG5H	CPD	CPB	—	—	—	—	—	—
30000Ah	CONFIG6L	_	—	—	—	—	—	WRT1	WRT0
30000Bh	CONFIG6H	WRTD	WRTB	WRTC	—	—	—	—	—
30000Ch	CONFIG7L	_	—	—	—	—	—	EBTR1	EBTR0
30000Dh	CONFIG7H	_	EBTRB	—	—	—	—	—	_

TABLE 24-3: SUMMARY OF CODE PROTECTION REGISTERS

Legend: Shaded cells are unimplemented.

24.5.1 PROGRAM MEMORY CODE PROTECTION

The program memory may be read to or written from any location using the table read and table write instructions. The device ID may be read with table reads. The Configuration registers may be read and written with the table read and table write instructions.

In normal execution mode, the CPn bits have no direct effect. CPn bits inhibit external reads and writes. A block of user memory may be protected from table writes if the WRTn Configuration bit is '0'. The EBTRn bits control table reads. For a block of user memory with the EBTRn bit set to '0', a table read instruction that executes from within that block is allowed to read. A table read instruction that executes from a location outside of that block is not allowed to read and will result in reading '0's. Figures 24-6 through 24-8 illustrate table write and table read protection.

Note: Code protection bits may only be written to a '0' from a '1' state. It is not possible to write a '1' to a bit in the '0' state. Code protection bits are only set to '1' by a full chip erase or block erase function. The full chip erase and block erase functions can only be initiated via ICSP operation or an external programmer.

FIGURE 24-6: TABLE WRITE (WRTn) DISALLOWED



Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
A01	NR	Resolution	—	_	10	bit	$\Delta VREF \ge 3.0V$
A03	EIL	Integral Linearity Error	—	_	<±1	LSb	$\Delta \text{VREF} \geq 3.0 \text{V}$
A04	Edl	Differential Linearity Error	—	_	<±1	LSb	$\Delta \text{VREF} \geq 3.0 \text{V}$
A06	EOFF	Offset Error	—	—	<±2	LSb	$\Delta VREF \ge 3.0V$
A07	Egn	Gain Error	—	_	<±1	LSb	$\Delta VREF \ge 3.0V$
A10	—	Monotonicity	Guaranteed ⁽¹⁾			-	$VSS \leq VAIN \leq VREF$
A20	$\Delta VREF$	Reference Voltage Range (VREFH – VREFL)	1.8 3	_		V V	$\begin{array}{l} VDDD<3.0V\\ VDD\geq3.0V \end{array}$
A21	Vrefh	Reference Voltage High	_	_	VDD + 3.0V	V	
A22	Vrefl	Reference Voltage Low	Vss – 0.3V			V	
A25	VAIN	Analog Input Voltage	VREFL		VREFH	V	
A30	ZAIN	Recommended Impedance of Analog Voltage Source	_	_	2.5	kΩ	
A50	IREF	VREF Input Current ⁽²⁾	—		5 150	μΑ μΑ	During VAIN acquisition. During A/D conversion cycle.

TABLE 27-24: A/D CONVERTER CHARACTERISTICS

Note 1: The A/D conversion result never decreases with an increase in the input voltage and has no missing codes.

2: VREFH current is from RA3/AN3/VREF+ pin or VDD, whichever is selected as the VREFH source. VREFL current is from RA2/AN2/VREF-/CVREF pin or VSS, whichever is selected as the VREFL source.

APPENDIX B: DEVICE DIFFERENCES

The differences between the devices listed in this data sheet are shown in Table B-1.

TABLE B-1: DEVICE DIFFERENCES

Features	PIC18F2221	PIC18F2321	PIC18F4221	PIC18F4321
Program Memory (Bytes)	4096	8192	4096	8192
Program Memory (Instructions)	2048	4096	2048	4096
Interrupt Sources	19	19	20	20
I/O Ports	Ports A, B, C, (E)	Ports A, B, C, (E)	Ports A, B, C, D, E	Ports A, B, C, D, E
Capture/Compare/PWM Modules	2	2	1	1
Enhanced Capture/Compare/ PWM Modules	0	0	1	1
Parallel Communications (PSP)	No	No	Yes	Yes
10-Bit Analog-to-Digital Module	10 input channels	10 input channels	13 input channels	13 input channels
Packages	28-pin SPDIP 28-pin SOIC 28-pin SSOP 28-pin QFN	28-pin SPDIP 28-pin SOIC 28-pin SSOP 28-pin QFN	40-pin PDIP 44-pin TQFP 44-pin QFN	40-pin PDIP 44-pin TQFP 44-pin QFN